

FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Specified Break-Before-Make Switching
- Low ON-State Resistance (1 Ω)
- Control Inputs Are 5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not liited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

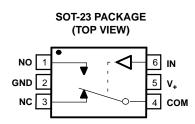
Low Total Harmonic Distortion

- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22

 2000-V Human-Body Model
 - (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

APPLICATIONS

- Cell Phones
- PDAs
- Portable Instrumentation



The TS5A3159-EP is a single-pole double-throw (SPDT) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and an excellent ON-state resistance matching with the break-before-make feature to prevent signal distortion during the transferring of a signal from one channel to another. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

| Configuration | 2:1 Multiplexer/ Demultiplexer (1 × SPDT) |
|--|---|
| Number of channels | 1 |
| ON-state resistance (r _{on}) | 1.1 Ω |
| ON-state resistance match (Δr_{on}) | 0.1 Ω |
| ON-state resistance flatness (ron(flat)) | 0.15 Ω |
| Turn-on/turn-off time (t _{ON} /t _{OFF}) | 20 ns/15 ns |
| Break-before-make time (t _{BBM}) | 12 ns |
| Charge injection (Q _C) | 36 pC |
| Bandwidth (BW) | 100 MHz |
| OFF isolation (O _{ISO}) | –65 dB at 1 MHz |
| Crosstalk (X _{TALK}) | –66 dB at 1 MHz |
| Total harmonic distortion (THD) | 0.01% |
| Leakage current (I _{NO(OFF)} /(I _{NC(OFF)}) | ±20 nA |
| Package option | 6-pin DBV |

Summary of Characteristics⁽¹⁾

(1) $V_+ = 5 \text{ V} \text{ and } T_A = 25^{\circ}\text{C}$

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

A

ORDERING INFORMATION

| T _A | PACKAG | E ⁽¹⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|--------------------|------------------|-----------------------|------------------|--|
| –55°C to 125°C | SOT (SOT-23) – DBV | Tape and reel | TS5A3159MDBVREP | JA8R | |

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1) www.ti.com/sc/package.

FUNCTION TABLE

| IN | NC TO COM, COM TO NC | NO TO COM, COM TO NO |
|----|-------------------------|-------------------------|
| L | ON | OFF |
| Н | OFF | ON |

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------------------------|--|--|------|------|------|
| V ₊ | Supply voltage range ⁽²⁾ | | -0.5 | 6.5 | V |
| $V_{NO} \ V_{COM}$ | Analog voltage range ⁽²⁾⁽³⁾⁽⁴⁾ | | | | |
| I _{I/OK} | Analog port diode current | V_{NO} , $V_{COM} < 0$ or V_{NO} , $V_{COM} > V_{+}$ | | ±50 | mA |
| I _{NO} I _{COM} | On-state switch current | V_{NO} , $V_{COM} = 0$ to V_{+} | | ±200 | mA |
| | On-state peak switch current ⁽⁵⁾ | | | ±400 | mA |
| V _{IN} | Digital input voltage range ⁽²⁾⁽³⁾ | | -0.5 | 6.5 | V |
| I _{IK} | Digital input clamp current | V _{IN} < 0 | | -50 | mA |
| | Continuous current through V ₊ or GND | | | ±100 | mA |
| θ_{JA} | Package thermal impedance ⁽⁶⁾ | | | 165 | °C/W |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Electrical Characteristics" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2)All voltages are with respect to ground, unless otherwise specified.

The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed. (3)

This value is limited to 5.5 V maximum. (4)

(5) (6) Pulse at 1-ms duration < 10% duty cycle.

The package thermal impedance is calculated in accordance with JESD 51-7.

Electrical Characteristics for 5-V Supply

 $V_{+} = 4.5$ V to 5.5 V (5 V nominal), $T_{A} = -55^{\circ}$ C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDI | TIONS | T _A | ۷, | MIN - | TYP ⁽¹⁾ | MAX | UNIT | |
|--|---|--|-----------------------------|----------------|-------------|-------|---------------------------|------------|------|--|
| Analog Switch | | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NC} , V _{NO} | | | | | 0 | | V+ | V | |
| Peak ON resistance | r _{peak} | $\begin{array}{l} 0 \leq V_{NO} \text{ or } V_{NC} \leq V_{+}, \\ I_{COM} = -30 \text{ mA}, \end{array}$ | Switch ON, See Figure 11 | 25°C Full | 4.5 V | | 1 | 1.5 1.5 | Ω | |
| ON-state resistance | r _{on} | V_{NO} or V_{NC} = 2.5 V, I_{COM} = -30 mA, | Switch ON, See Figure 11 | 25°C Full | 4.5 V | | 0.75 | 1.1 1.3 | Ω | |
| ON-state resistance match between channels | Δr_{on} | $V_{NO} \text{ or } V_{NC} = 2.5 \text{ V},$ $I_{COM} = -30 \text{ mA},$ | Switch ON, See Figure 11 | 25°C | 4.5 V | | 0.1 | | Ω | |
| ON-state resistance | r ann | $\begin{array}{l} 0 \leq V_{NO} \text{ or } V_{NC} \leq V_{+}, \\ I_{COM} = -30 \text{ mA} \end{array}$ | Switch ON, | 25°C | 4.5 V | | 0.233 | | Ω | |
| flatness | r _{on(flat)} | V_{NO} or V_{NC} = 1 V, 1.5 V, 2.5 V, I_{COM} = –30 mA | See Figure 11 | 20 0 | | | 0.15 | | | |
| NC, NO | I _{NC(OFF)} , | V_{NC} or $V_{NO} = 4.5 V$, | Switch OFF, | 25°C | 55 \ | -6 | 0.2 | 4 | nA | |
| OFF leakage current | I _{NO(OFF)} | $V_{COM} = 0,$ | See Figure 12 | Full | 5.5 V | -20 | | 60 | | |
| NC, NO | I _{NC(ON)} , | V_{NC} or $V_{NO} = 4.5 V$, | Switch ON, | 25°C | | -6 | 2.8 | 4 | | |
| ON leakage current | I _{NO(ON)} | V _{COM} = Open, | See Figure 13 | Full | 5.5 V | -40 | | 70 | nA | |
| COM | | V _{NC} or V _{NO} = 4.5 V or Open, | Switch ON, | 25°C | | -4 | 0.47 | 7 | | |
| ON leakage current | I _{COM(ON)} | $V_{\rm COM} = 4.5 \text{ V},$ | See Figure 13 | Full | 5.5 V | -40 | | 80 | nA | |
| Digital Control | Input (IN) | | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | 2.4 | | 5.5 | V | |
| Input logic low | V _{IL} | | | Full | | 0 | | 0.8 | V | |
| Input leakage current | I _{IH} , I _{IL} | V ₁ = 5.5 V or 0 | | Full | 5.5 V | -1 | | 1 | μΑ | |

(1) $T_A = 25^{\circ}C$

TS5A3159-EP 1-Ω SPDT ANALOG SWITCH

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Electrical Characteristics for 5-V Supply (continued)

 V_{\star} = 4.5 V to 5.5 V (5 V nominal), T_{A} = –55°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | NDITIONS | TA | ٧. | MIN TYP ⁽¹⁾ | MAX | UNIT |
|------------------------------|--|--|--|--------------|-------------------|------------------------|----------|------|
| Dynamic | | | | | | | | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ R _L = 50 Ω, | C _L = 35 pF, See Figure 15 | 25°C Full | 4.5 V to 5.5 V | 20 | 35 40 | ns |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ | $C_L = 35 \text{ pF},$ | 25°C | 4.5 V to | 15 | 20 | ns |
| | OFF | $R_L = 50 \Omega,$ | See Figure 15 | Full | 5.5 V | | 35 | |
| Break-before- make time | t _{BBM} | $V_{NC} = V_{NO} = V_{+}/2,$ $R_{1} = 50 \ \Omega,$ | C _L = 35 pF, See Figure 16 | 25°C Full | 4.5 V to 5.5 V | 1 12 | 14.5 | ns |
| Charge injection | Q _C | $C_L = 1 \text{ nF},$ $V_{GEN} = 0 \text{ V},$ | See Figure 20 | 25°C | 5 V | 36 | | рС |
| NC, NO OFF capacitance | C _{NC(OFF)} , C _{NO(OFF)} | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 14 | 25°C | 5 V | 23 | | pF |
| NC, NO ON capacitance | C _{NC(ON)} , C _{NO(ON)} | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 14 | 25°C | 5 V | 84 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_{+}$ or GND, Switch ON, | See Figure 14 | 25°C | 5 V | 84 | | pF |
| Digital input capacitance | C _{IN} | $V_{IN} = V_{+}$ or GND, | See Figure 14 | 25°C | 5 V | 2.1 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 17 | 25°C | 5 V | 100 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch OFF, See Figure 18 | 25°C | 5 V | -65 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch ON, See Figure 19 | 25°C | 5 V | -65 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 600 Hz to 20 kHz, See Figure 21 | 25°C | 5 V | 0.01 | | % |
| Supply | | 1 | | 1 | · · · · · | | | |
| Positive supply current | I+ | $V_{IN} = V_{+}$ or GND, | Switch ON or OFF | Full | 5.5 V | | 0.1 | μA |

Electrical Characteristics for 3.3-V Supply

 $V_{+} = 3 \text{ V}$ to 3.6 V (3.3 V nominal), $T_{A} = -55^{\circ}\text{C}$ to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | DITIONS | T _A | V. | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|--|---|---|------------------------------|----------------|----------|-----|--------------------|--------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NC} , V _{NO} | | | | | 0 | | V+ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \text{ or } V_{NC} \le V_+,$ $I_{COM} = -24 \text{ mA},$ | Switch ON, See Figure 11 | 25°C Full | 3 V | | 1.35 | 2.15 2.15 | Ω |
| ON-state | | V_{NO} or $V_{NC} = 2 V$, | Switch ON. | 25°C | <u> </u> | | 1.15 | 1.7 | |
| resistance | r _{on} | $I_{COM} = -24 \text{ mA},$ | See Figure 11 | Full | 3 V | | | 1.7 | Ω |
| ON-state resistance match between channels | Δr_{on} | V_{NO} or V_{NC} = 2 V, 0.8 V, I_{COM} = -24 mA, | Switch ON, See Figure 11 | 25°C | 3 V | | 0.11 | | Ω |
| ON-state | _ | $0 \le V_{NO} \text{ or } V_{NC} \le V_+,$ $I_{COM} = -24 \text{ mA}$ | Switch ON, | 2500 | 3 V | | 0.225 | | Ω |
| resistance flatness | r _{on(flat)} | V_{NO} or $V_{NC} = 2 V$, 0.8 V, $I_{COM} = -24 \text{ mA}$ | See Figure 11 | 25°C | | | 0.25 | | |
| NC, NO OFF leakage current | I _{NC(OFF)} , I _{NO(OFF)} | | Switch OFF, See Figure 12 | 25°C | 3.6 V | | 0.2 | | nA |
| NC, NO ON leakage current | I _{NC(ON)} , I _{NO(ON)} | V_{NC} or V_{NO} = 3 V, V_{COM} = Open, | Switch ON, See Figure 13 | 25°C | 3.6 V | | 2.8 | | nA |
| COM ON leakage current | I _{COM(ON)} | V_{NC} or V_{NO} = 3 V or Open, V_{COM} = 3 V, | Switch ON, See Figure 13 | 25°C | 3.6 V | | 0.47 | | nA |
| Digital Control I | nput (IN) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | 2 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | 0.6 | | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | Full | 3.6 V | -1 | | 1 | μΑ |

(1) $T_A = 25^{\circ}C$

TS5A3159-EP $1-\Omega$ SPDT ANALOG SWITCH

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Electrical Characteristics for 3.3-V Supply (continued)

V₊ = 3 V to 3.6 V (3.3 V nominal), T_A = –55°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | DITIONS | TA | ٧, | MIN TYP ⁽¹⁾ | MAX | UNIT |
|------------------------------|---|--|--|------|-----------------|------------------------|-----|------|
| Dynamic | | | | | | | | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 15 | 25°C | 3 V to 3.6 V | 30 | 40 | ns |
| | | $K_{L} = 50.32,$ | - | Full | 3.0 V | | 55 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ | $C_{L} = 35 \text{ pF},$ | 25°C | 3 V to | 20 | 25 | ns |
| | | R _L = 50 Ω, | See Figure 15 | Full | 3.6 V | | 40 | - |
| Break-before- | t | $V_{\rm NC} = V_{\rm NO} = V_{+}/2,$ | C _L = 35 pF, | 25°C | 3 V to | 1 21 | 29 | ns |
| make time | t _{BBM} | $R_L = 50 \Omega$, | See Figure 16 | Full | 3.6 V | 1 | | 115 |
| Charge injection | Q _C | $C_L = 1 \text{ nF},$ $V_{GEN} = 0 \text{ V},$ | See Figure 20 | 25°C | 3.3 V | 20 | | рС |
| NC, NO OFF capacitance | $\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$ | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 14 | 25°C | 3.3 V | 23 | | pF |
| NC, NO ON capacitance | C _{NC(ON)} , C _{NO(ON)} | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 14 | 25°C | 3.3 V | 84 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_+$ or GND, Switch ON, | See Figure 14 | 25°C | 3.3 V | 84 | | pF |
| Digital input capacitance | C _{IN} | $V_{IN} = V_+ \text{ or } GND,$ | See Figure 14 | 25°C | 3.3 V | 2.1 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 17 | 25°C | 3.3 V | 100 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch OFF, See Figure 18 | 25°C | 3.3 V | -65 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch ON, See Figure 19 | 25°C | 3.3 V | -65 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 600 Hz to 20 kHz, See Figure 21 | 25°C | 3.3 V | 0.015 | | % |
| Supply | | | | • | | | | |
| Positive supply current | I+ | $V_{IN} = V_{+}$ or GND, | Switch ON or OFF | Full | 3.6 V | | 0.1 | μA |

Electrical Characteristics for 2.5-V Supply

 V_{\star} = 2.3 V to 2.7 V (2.5 V nominal), T_{A} = –55°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST COND | ITIONS | T _A | V. | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|--|---|--|------------------------------|----------------|----------|-----|--------------------|-----|------|
| Analog Switch | | | | U | | | | | |
| Analog signal range | V _{COM} , V _{NC} , V _{NO} | | | | | 0 | | V+ | V |
| Peak ON | r | $0 \le V_{NO}$ or $V_{NC} \le V_+$, | Switch ON, | 25°C | 2.5 V | | 1.7 | 2.7 | Ω |
| resistance | r _{peak} | $I_{COM} = -8 \text{ mA},$ | See Figure 11 | Full | 2.5 V | | | 2.9 | 52 |
| ON-state | r | V_{NO} or V_{NC} = 1.8 V, | Switch ON, | 25°C | 2.5 V | | 1.45 | 2.3 | Ω |
| resistance | r _{on} | $I_{COM} = -8 \text{ mA},$ | See Figure 11 | Full | 2.5 V | | | 2.5 | 22 |
| ON-state resistance match between channels | Δr_{on} | $V_{NO} \text{ or } V_{NC}$ = 0.8 V, 1.8 V, I_{COM} = –8 mA, | Switch ON, See Figure 11 | 25°C | 2.5 V | | 0.7 | | Ω |
| ON-state resistance | r | $\begin{array}{l} 0 \leq V_{NO} \text{ or } V_{NC} \leq V_{+}, \\ I_{COM} = -8 \text{ mA} \end{array}$ | Switch ON, | 25°C | °C 2.5 V | | 0.5 | | Ω |
| flatness | r _{on(flat)} | $V_{NO} \text{ or } V_{NC}$ = 0.8 V, 1.8 V, I_{COM} = –8 mA | See Figure 11 | 25 0 | | | 0.45 | | 22 |
| NC, NO OFF leakage current | I _{NC(OFF)} , I _{NO(OFF)} | | Switch OFF, See Figure 12 | 25°C | 2.7 V | | 0.2 | | nA |
| NC, NO ON leakage current | I _{NC(ON)} , I _{NO(ON)} | V_{NC} or V_{NO} = 2.3 V, V_{COM} = Open, | Switch ON, See Figure 13 | 25°C | 2.7 V | | 2.8 | | nA |
| COM ON leakage current | I _{COM(ON)} | $V_{\rm NC}$ or $V_{\rm NO}$ = 2.3 V or Open, $V_{\rm COM}$ = 2.3 V, | Switch ON, See Figure 13 | 25°C | 2.7 V | | 0.47 | | nA |
| Digital Control I | nput (IN) | | | i | | | | | |
| Input logic high | V _{IH} | | | Full | | 1.8 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | 0.6 | | V |
| Input leakage current | I _{IH} , I _{IL} | V ₁ = 5.5 V or 0 | | Full | 2.7 V | -1 | | 1 | μΑ |

(1) $T_A = 25^{\circ}C$

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Electrical Characteristics for 2.5-V Supply (continued)

 V_{\star} = 2.3 V to 2.7 V (2.5 V nominal), T_{A} = –55°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | DITIONS | TA | ٧. | MIN TYP ⁽¹⁾ | MAX | UNIT |
|------------------------------|---|---|--|------|----------|------------------------|-----|------|
| Dynamic | | | | | | | | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ | $C_L = 35 \text{ pF},$ | 25°C | 2.3 V to | 40 | 55 | ns |
| | ON | R _L = 50 Ω, | See Figure 15 | Full | 2.7 V | | 70 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ | C _L = 35 pF, | 25°C | 2.3 V to | 30 | 40 | ns |
| | *OFF | R _L = 50 Ω, | See Figure 15 | Full | 2.7 V | | 55 | 110 |
| Break-before- | t | $V_{NC} = V_{NO} = V_{+}/2,$ | C _L = 35 pF, | 25°C | 2.3 V to | 1 33 | 39 | ns |
| make time | t _{BBM} | $R_L = 50 \Omega$, | See Figure 16 | Full | 2.7 V | 1 | | 115 |
| Charge injection | Q _C | $C_L = 1 \text{ nF},$ $V_{GEN} = 0 \text{ V},$ | See Figure 20 | 25°C | 2.5 V | 13 | | рС |
| NC, NO OFF capacitance | $\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$ | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 14 | 25°C | 2.5 V | 23 | | pF |
| NC, NO ON capacitance | C _{NC(ON)} , C _{NO(ON)} | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 14 | 25°C | 2.5 V | 84 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_+$ or GND, Switch ON, | See Figure 14 | 25°C | 2.5 V | 84 | | pF |
| Digital input capacitance | C _{IN} | $V_{IN} = V_+ \text{ or } GND,$ | See Figure 14 | 25°C | 2.5 V | 2.1 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 17 | 25°C | 2.5 V | 100 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch OFF, See Figure 18 | 25°C | 2.5 V | -64 | | dB |
| Crosstalk | X _{TALK} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch ON, See Figure 19 | 25°C | 2.5 V | -64 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 600 Hz to 20 kHz, See Figure 21 | 25°C | 2.5 V | 0.025 | | % |
| Supply | | | | | | | | |
| Positive supply current | l+ | $V_{IN} = V_+ \text{ or GND},$ | Switch ON or OFF | Full | 2.7 V | | 0.1 | μΑ |

Electrical Characteristics for 1.8-V Supply

 V_{+} = 1.65 V to 1.95 V (1.8 V nominal), T_{A} = -55°C to 125°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | DITIONS | T _A | ۷. | MIN TYP ⁽¹⁾ | MAX | UNIT |
|--|---|---|------------------------------|----------------|--------|------------------------|-----|------|
| Analog Switch | | • | | | | | | |
| Analog signal range | V _{COM} , V _{NC} , V _{NO} | | | | | 0 | V+ | V |
| Peak ON | r . | $0 \le V_{NO} \text{ or } V_{NC} \le V_+,$ | Switch ON, | 25°C | 1.8 V | 4 | 4.9 | Ω |
| resistance | r _{peak} | $I_{COM} = -2 \text{ mA},$ | See Figure 11 | Full | 1.0 V | 7 | | 52 |
| ON-state | r _{on} | V_{NO} or V_{NC} = 1.5 V, | Switch ON, | 25°C | 1.8 V | 1.7 | 3.2 | Ω |
| resistance | 'on | $I_{COM} = -2 \text{ mA},$ | See Figure 11 | Full | 1.0 V | | 4.2 | |
| ON-state | | | | 25°C | | 0.7 | | |
| resistance match between channels | Δr_{on} | V_{NO} or V_{NC} = 0.6 V, 1.5 V, I_{COM} = -2 mA, | Switch ON, See Figure 11 | Full | 1.8 V | 0.7 | | Ω |
| | | $0 \le V_{NO}$ or $V_{NC} \le V_+$, | | 25°C | | 1.85 | | Ω |
| ON-state | - | $I_{COM} = -2 \text{ mA}$ | Switch ON, | Full | 4.0.1/ | 1.85 | | |
| resistance flatness | r _{on(flat)} | $V_{\rm NO} \text{ or } V_{\rm NC} = 0.6 \text{ V}, 1.5 \text{ V},$ | See Figure 11 | 25°C | 1.8 V | 0.9 | | |
| | | $I_{COM} = -2 \text{ mA}$ | | Full | - | 0.9 | | |
| NC, NO OFF leakage current | I _{NC(OFF)} , I _{NO(OFF)} | V_{NC} or V_{NO} = 1.65 V, V_{COM} = 0, | Switch OFF, See Figure 12 | 25°C | 1.95 V | 0.2 | | nA |
| NC, NO ON leakage current | I _{NC(ON)} , I _{NO(ON)} | V_{NC} or V_{NO} = 1.65 V, V_{COM} = Open, | Switch ON, See Figure 13 | 25°C | 1.95 V | 2.8 | | nA |
| COM ON leakage current | I _{COM(ON)} | V_{NC} or V_{NO} = 1.65 V or Open, V_{COM} = 1.65 V, | Switch ON, See Figure 13 | 25°C | 1.95 V | 0.47 | | nA |
| Digital Control In | nput (IN) | | | | | | | |
| Input logic high | V _{IH} | | | Full | | 1.5 | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 0.6 | | V |
| Input leakage current | I _{IH} , I _{IL} | V ₁ = 5.5 V or 0 | | Full | 1.95 V | -1 | 1 | μΑ |

(1) $T_A = 25^{\circ}C$

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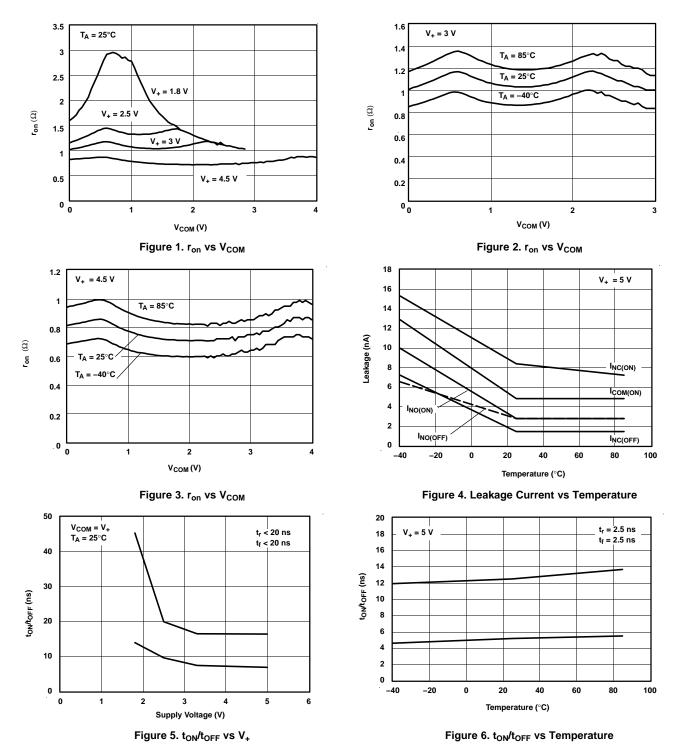
SCDS217B-DECEMBER 2005-REVISED JANUARY 2006

Electrical Characteristics for 1.8-V Supply (continued)

 V_{\star} = 1.65 V to 1.95 V (1.8 V nominal), T_{A} = –55°C to 125°C (unless otherwise noted)

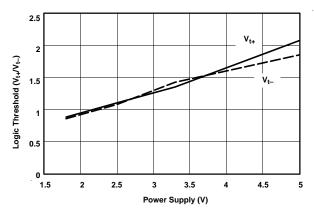
| PARAMETER | SYMBOL | TEST CON | DITIONS | TA | ٧, | MIN TYP ⁽¹⁾ | MAX | UNIT |
|------------------------------|---|---|------------------------------|------|-----------|------------------------|-----|------|
| Dynamic | | | | | · | | | |
| Turn-on time | | $V_{COM} = V_+,$ | C ₁ = 35 pF, | 25°C | 1.65 V to | 65 | 70 | ns |
| rum-on time | t _{ON} | $R_{L} = 50 \Omega,$ | See Figure 15 | Full | 1.95 V | | 95 | ns |
| Turn-off time | t | $V_{COM} = V_+,$ | C _L = 35 pF, | 25°C | 1.65 V to | 40 | 55 | ns |
| rum-on time | t _{OFF} | $R_L = 50 \Omega$, | See Figure 15 | Full | 1.95 V | | 70 | 113 |
| Break-before- | toou | $V_{\rm NC} = V_{\rm NO} = V_{\rm +}/2,$ | C _L = 35 pF, | 25°C | 1.65 V to | 1 60 | 72 | ns |
| make time | t _{BBM} | $R_L = 50 \Omega,$ | See Figure 16 | Full | 1.95 V | 0.5 | | 113 |
| Charge injection | Q _C | $C_L = 1 \text{ nF},$ $V_{GEN} = 0 \text{ V},$ | See Figure 20 | 25°C | 1.8 V | 13 | | рС |
| NC, NO OFF capacitance | $\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$ | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 14 | 25°C | 1.8 V | 23 | | pF |
| NC, NO ON capacitance | C _{NC(ON)} , C _{NO(ON)} | V_{NC} or $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 14 | 25°C | 1.8 V | 84 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 14 | 25°C | 1.8 V | 84 | | pF |
| Digital input capacitance | C _{IN} | $V_{IN} = V_{+} \text{ or GND},$ | See Figure 14 | 25°C | 1.8 V | 2.1 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 17 | 25°C | 1.8 V | 100 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega,$ f = 1 MHz, | Switch OFF, See Figure 18 | 25°C | 1.8 V | -63 | | dB |
| Crosstalk | X _{TALK} | $\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$ | Switch ON, See Figure 19 | 25°C | 1.8 V | -63 | | dB |
| Supply | | | | | | | | |
| Positive supply current | I+ | $V_{IN} = V_{+}$ or GND, | Switch ON or OFF | Full | 1.95 V | | 0.1 | μA |

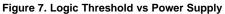
TYPICAL PERFORMANCE



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TYPICAL PERFORMANCE (continued)





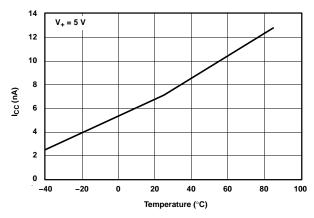


Figure 9. Power-Supply Current vs Temperature

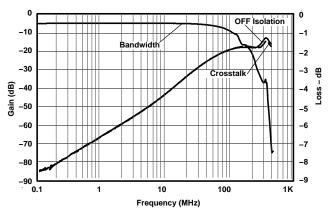


Figure 8. Frequency Response

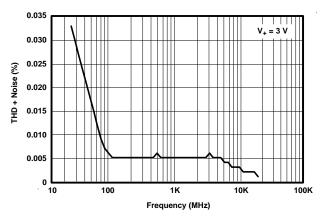


Figure 10. Total Harmonic Distortion (THD) vs Frequency

PIN DESCRIPTION

| PIN NO. | NAME | DESCRIPTION | | | | | |
|------------|------|--|--|--|--|--|--|
| 1 | NO | Normally open | | | | | |
| 2 | GND | Digital ground | | | | | |
| 3 | NC | Normally closed | | | | | |
| 4 | COM | Common | | | | | |
| 5 | V+ | Power supply | | | | | |
| 6 | IN | Digital control to connect COM to NO or NC | | | | | |

PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
|-----------------------------------|--|
| V _{COM} | Voltage at COM |
| V _{NC} | Voltage at NC |
| V _{NO} | Voltage at NO |
| r _{on} | Resistance between COM and NO ports when the channel is ON |
| r _{peak} | Peak on-state resistance over a specified voltage range |
| Δr_{on} | Difference of r _{on} between channels in a specific device |
| r _{on(flat)} | Difference between the maximum and minimum value of ron in a channel over the specified range of conditions |
| I _{NC(OFF)} | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state under worst-case input and output conditions |
| I _{NO(OFF)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state |
| I _{NC(ON)} | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open |
| I _{NO(ON)} | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open |
| I _{COM(ON)} | Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON state and the output (NO) open |
| VIH | Minimum input voltage for logic high for the control input (IN) |
| V _{IL} | Maximum input voltage for logic low for the control input (IN) |
| V _{IN} | Voltage at IN |
| I _{IH} , I _{IL} | Leakage current measured at IN |
| t _{ON} | Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. |
| t _{OFF} | Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. |
| t _{BBM} | Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO), when the control signal changes state. |
| Q _C | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance and ΔV_{COM} is the change in analog output voltage. |
| C _{NC(OFF)} | Capacitance at the NC port when the corresponding channel (NC to COM) is OFF |
| C _{NO(OFF)} | Capacitance at the NO port when the corresponding channel (NO to COM) is OFF |
| C _{NC(ON)} | Capacitance at the NC port when the corresponding channel (NC to COM) is ON |
| C _{NO(ON)} | Capacitance at the NO port when the corresponding channel (NO to COM) is ON |
| C _{COM(ON)} | Capacitance at the COM port when the corresponding channel (COM to NO) is ON |
| C _{IN} | Capacitance of IN |
| O _{ISO} | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state. |
| X _{TALK} | Crosstalk is a measurement of unwanted signal coupling from an ON channel to an adjacent ON channel (NC1 to NC2). This is measured in a specific frequency and in dB. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |

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PARAMETER DESCRIPTION (continued)

| SYMBOL | DESCRIPTION |
|----------------|--|
| I ₊ | Static power-supply current with the control (IN) pin at V_+ or GND |
| ΔI_+ | This is the increase in I+ for each control (IN) input that is at the specified voltage, rather than at V+ or GND. |

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PARAMETER MEASUREMENT INFORMATION

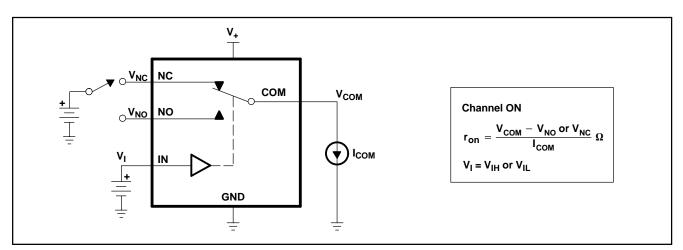


Figure 11. ON-State Resistance (ron)

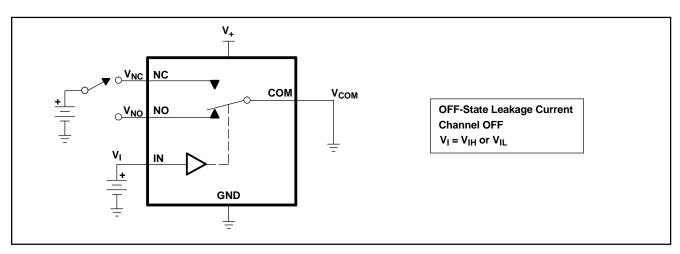


Figure 12. OFF-State Leakage Current (I_{NC(OFF)}, I_{NO(OFF)})

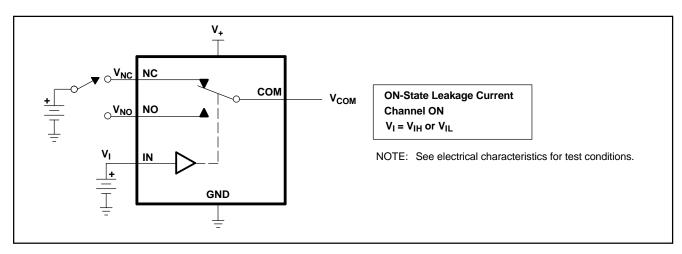


Figure 13. ON-State Leakage Current (I_{COM(ON)}, I_{NC(ON)}, I_{NO(ON)})

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PARAMETER MEASUREMENT INFORMATION (continued)

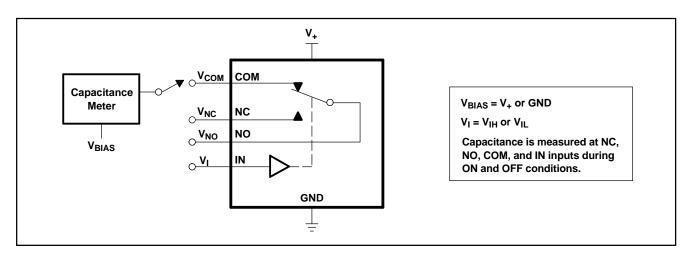
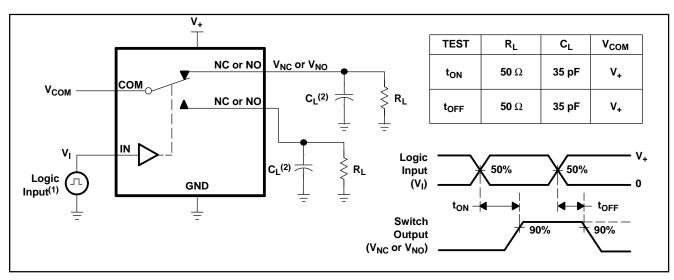


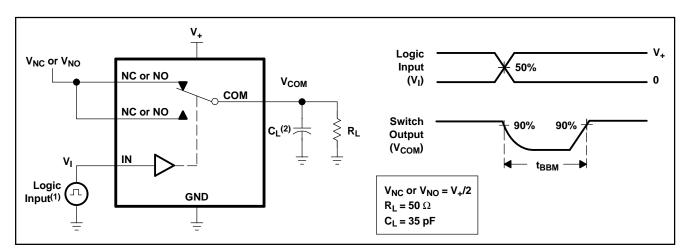
Figure 14. Capacitance (C₁, C_{COM(ON)}, C_{NC(OFF)}, C_{NO(OFF)}, C_{NC(ON)}, C_{NO(ON)})



- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z₀ = 50 Ω , t_r < 5 ns, t_f < 5 ns.
- (2) C_L includes probe and jig capacitance.

Figure 15. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

PARAMETER MEASUREMENT INFORMATION (continued)



- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r < 5 ns, t_f < 5 ns.
- (2) C_L includes probe and jig capacitance.

Figure 16. Break-Before-Make Time (t_{BBM})

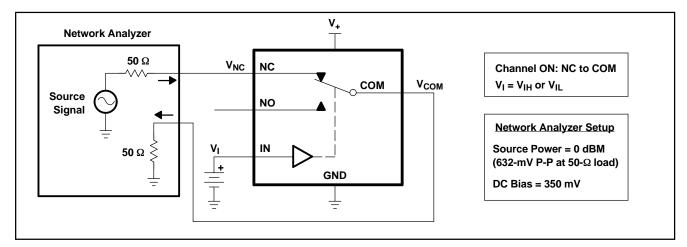


Figure 17. Bandwidth (BW)

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PARAMETER MEASUREMENT INFORMATION (continued)

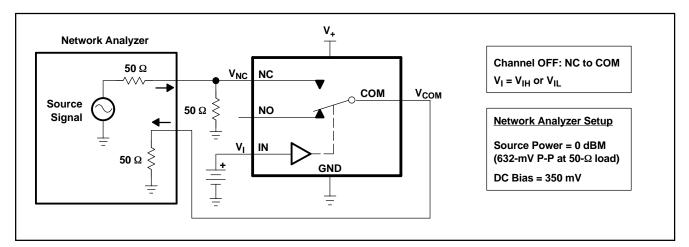


Figure 18. OFF Isolation (O_{ISO})

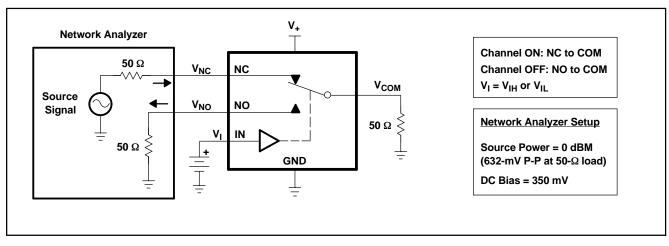
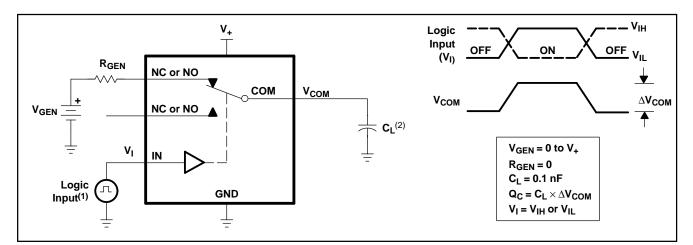


Figure 19. Crosstalk (X_{TALK})



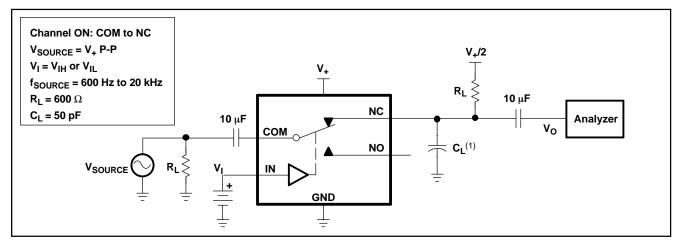
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PARAMETER MEASUREMENT INFORMATION (continued)

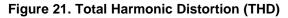


- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z₀ = 50 Ω , t_r < 5 ns, t_f < 5 ns.
- (2) C_L includes probe and jig capacitance.





(1) C_L includes probe and jig capacitance.





11-Apr-2013

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | • | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|------------------|--------------------|--------------|-------------------|---------|
| | (1) | | Drawing | | Qty | (2) | | (3) | | (4) | |
| TS5A3159MDBVREP | ACTIVE | SOT-23 | DBV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -55 to 125 | JA8R | Samples |
| V62/06613-01XE | ACTIVE | SOT-23 | DBV | 6 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -55 to 125 | JA8R | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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Catalog: TS5A3159

• Automotive: TS5A3159-Q1

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| TS5A3159MDBVREP | SOT-23 | DBV | 6 | 3000 | 180.0 | 8.4 | 3.23 | 3.17 | 1.37 | 4.0 | 8.0 | Q3 |

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

10-Jun-2014



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TS5A3159MDBVREP | SOT-23 | DBV | 6 | 3000 | 202.0 | 201.0 | 28.0 |

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
 - A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
 - E Falls within JEDEC MO-178 Variation AB, except minimum lead width.



LAND PATTERN DATA



NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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